### 1.5V/1.8V 25-BIT CONFIGURABLE REGISTERED BUFFER WITH ADDRESS-PARITY TEST

## FEATURES

## - Member of the Texas Instruments Widebus+ ${ }^{\text {TM }}$ Family

- Pinout Optimizes DDR2 DIMM PCB Layout
- Configurable as 25 -Bit 1:1 or 14-Bit 1:2 Registered Buffer
- Chip-Select Inputs Gate the Data Outputs from Changing State and Minimizes System Power Consumption
- Output Edge-Control Circuitry Minimizes

Switching Noise in an Unterminated Line

- Supports 1.5 V and 1.8 V Supply Voltage Range
- Differential Clock (CLK and CLK) Inputs
- Supports LVCMOS Switching Levels on the Control and RESET Inputs
- Checks Parity on DIMM-Independent Data Inputs
- Able to Cascade With a Second SN74SSTEB32866
- Supports Industrial Temperature Range $\left(-40^{\circ} \mathrm{C}\right.$ to $85^{\circ} \mathrm{C}$ )


## DESCRIPTION

This 25 -bit $1: 1$ or 14 -bit $1: 2$ configurable registered buffer is designed for $1.425-\mathrm{V}$ to $1.9-\mathrm{V}$ VCC operation. In the $1: 1$ pinout configuration, only one device per DIMM is required to drive nine SDRAM loads. In the 1:2 pinout configuration, two devices per DIMM are required to drive 18 SDRAM loads.
All inputs are SSTL_18, except the reset ( $\overline{\operatorname{RESET}}$ ) and control (Cn) inputs, which are LVCMOS. All outputs are edge-controlled circuits optimized for unterminated DIMM loads and meets SSTL_18 and SSTL_15 specifications (depending on Supply voltage level), except the open-drain error (QERR) output.
The SN74SSTEB32866 operates from a differential clock (CLK and CLK). Data are registered at the crossing of CLK going high and CLK going low.
The SN74SSTEB32866 accepts a parity bit from the memory controller on the parity bit (PAR_IN) input, compares it with the data received on the DIMM-independent D-inputs (D2-D3, D5-D6, D8-D25 when C0 $=0$ and C1 = 0; D2-D3, D5-D6, D8-D14 when C0 $=0$ and C1 $=1$; or D1-D6, D8-D13 when C0 $=1$ and C1 $=1$ ) and indicates whether a parity error has occurred on the open-drain QERR pin (active low). The convention is even parity; i.e., valid parity is defined as an even number of ones across the DIMM-independent data inputs, combined with the parity input bit. To calculate parity, all DIMM-independent data inputs must be tied to a known logic state.

When used as a single device, the C0 and C1 inputs are tied low. In this configuration, parity is checked on the PAR_IN input signal, which arrives one cycle after the input data to which it applies. Two clock cycles after the data are registered, the corresponding partial-parity-out (PPO) and QERR signals are generated.
When used in pairs, the C0 input of the first register is tied low, and the C0 input of the second register is tied high. The C1 input of both registers are tied high. Parity, which arrives one cycle after the data input to which it applies, is checked on the PAR IN input signal of the first device. Two clock cycles after the data are registered, the corresponding PPO and QERR signals are generated on the second device. The PPO output of the first register is cascaded to the PAR_IN of the second SN74SSTEB32866. The QERR output of the first SN74SSTEB32866 is left floating, and the valid error information is latched on the QERR output of the second SN74SSTEB32866.

## ORDERING INFORMATION

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE $^{(1)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | LFBGA-ZWL | Tape and reel | SN74SSTEB32866ZWLR | SEB866 |

(1) Package drawings, packing quantities, thermal data, symbolization, PCB design guidelines available at www.ti.com/sc/package.

[^0]Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## DESCRIPTION (CONTINUED)

If an error occurs and the $\overline{\text { QERR }}$ output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low. If two or more consecutive parity errors occur, the QERR output is driven low and latched low for a clock duration equal to the parity-error duration or until RESET is driven low. The DIMM-dependent signals (DCKE, $\overline{\text { DCS }}$, DODT, and CSR) are not included in the parity-check computation.
The C0 input controls the pinout configuration of the 1:2 pinout from register-A configuration (when low) to register-B configuration (when high). The C1 input controls the pinout configuration from 25-bit 1:1 (when low) to 14-bit 1:2 (when high). C0 and C1 should not be switched during normal operation. They should be hard-wired to a valid low or high level to configure the register in the desired mode. In the 25 -bit 1:1 pinout configuration, the A6, D6, and H 6 terminals are driven low and are do-not-use (DNU) pins.
In the DDR2 RDIMM application, $\overline{\text { RESET }}$ is specified to be completely asynchronous with respect to CLK and $\overline{C L K}$. Therefore, no timing relationship can be ensured between the two. When entering reset, the register is cleared, and the data outputs are driven low quickly, relative to the time required to disable the differential input receivers. However, when coming out of reset, the register becomes active quickly, relative to the time required to enable the differential input receivers. As long as the data inputs are low, and the clock is stable during the time from the low-to-high transition of RESET until the input receivers are fully enabled, the design of the SN74SSTEB32866 ensures that the outputs remain low, thus ensuring there will be no glitches on the output.
To ensure defined outputs from the register before a stable clock has been supplied, $\overline{R E S E T}$ must be held in the low state during power up.
The device supports low-power standby operation. When RESET is low, the differential input receivers are disabled, and undriven (floating) data, clock, and reference voltage ( $\mathrm{V}_{\mathrm{REF}}$ ) inputs are allowed. In addition, when RESET is low, all registers are reset and all outputs are forced low, except QERR. The LVCMOS RESET and Cn inputs always must be held at a valid logic high or low level.
The device also supports low-power active operation by monitoring both system chip select ( $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ ) inputs and gates the Qn and PPO outputs from changing states when both DCS and CSR inputs are high. If either DCS or CSR input is low, the Qn and PPO outputs function normally. Also, if the internal low-power signal (LPS1) is high (one cycle after $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ go high), the device gates the $\overline{\text { QERR }}$ output from changing states. If $\overline{\text { LPS1 }}$ is low, the $\overline{\text { QERR }}$ output functions normally. The $\overline{\text { RESET input has priority over the } \overline{\mathrm{DCS}} \text { and } \overline{\mathrm{CSR}} \text { control }}$ and, when driven low, forces the Qn and PPO outputs low and forces the QERR output high. If the DCS control functionality is not desired, the $\overline{C S R}$ input can be hard-wired to ground, in which case the setup-time requirement for $\overline{\mathrm{DCS}}$ is the same as for the other D data inputs. To control the low-power mode with $\overline{\mathrm{DCS}}$ only, the $\overline{\mathrm{CSR}}$ input should be pulled up to $\mathrm{V}_{\mathrm{CC}}$ through a pull-up resistor.

The two $\mathrm{V}_{\text {REF }}$ pins (A3 and T3) are connected together internally by approximately $150 \Omega$. However, it is necessary to connect only one of the two $\mathrm{V}_{\text {REF }}$ pins to the external $\mathrm{V}_{\text {REF }}$ power supply. An unused $\mathrm{V}_{\text {REF }}$ pin should be terminated with a $\mathrm{V}_{\text {REF }}$ coupling capacitor.

|  | PACKAGE (TOP VIEW) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 12 | 2 |  |  |  |  |
| $A \quad(0)()()()()$ |  |  |  |  |  |  |  |
| B | () () () () () () |  |  |  |  |  |  |
| c | () () () () () () |  |  |  |  |  |  |
| D | () () () () () () |  |  |  |  |  |  |
| E | () () () () () () |  |  |  |  |  |  |
| F | () () () () () () |  |  |  |  |  |  |
| G | () () () () () () |  |  |  |  |  |  |
| H | () () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
| K | () () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
| M | () () () () () () |  |  |  |  |  |  |
| N | () () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
|  | () () () () () |  |  |  |  |  |  |

Terminal Assignments for 1:1 Register-A (C0 = 0, C1 = 0)

|  | 1 | 2 | 3 | 4 | 5 | 6 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | D1 (DCKE) | PPO | $V_{\text {REF }}$ | $\mathrm{V}_{\text {CC }}$ | Q1 (QCKE) | DNU |
| B | D2 | D15 | GND | GND | Q2 | Q15 |
| C | D3 | D16 | $\mathrm{V}_{\mathrm{CC}}$ | $V_{\text {CC }}$ | Q3 | Q16 |
| D | D4 (DODT) | QERR | GND | GND | Q4 (QODT) | DNU |
| E | D5 | D17 | $V_{\text {CC }}$ | $V_{\text {CC }}$ | Q5 | Q17 |
| F | D6 | D18 | GND | GND | Q6 | Q18 |
| G | PAR_IN | RESET | $\mathrm{V}_{\mathrm{CC}}$ | $V_{\text {cC }}$ | C1 | C0 |
| H | CLK | D7 ( $\overline{\mathrm{CCS}}$ ) | GND | GND | Q7 ( $\overline{\mathrm{QCS}})$ | DNU |
| J | $\overline{\text { CLK }}$ | $\overline{\mathrm{CSR}}$ | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | NC | NC |
| K | D8 | D19 | GND | GND | Q8 | Q19 |
| L | D9 | D20 | $\mathrm{V}_{\mathrm{CC}}$ | $V_{\text {CC }}$ | Q9 | Q20 |
| M | D10 | D21 | GND | GND | Q10 | Q21 |
| N | D11 | D22 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q11 | Q22 |
| P | D12 | D23 | GND | GND | Q12 | Q23 |
| R | D13 | D24 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q13 | Q24 |
| T | D14 | D25 | $V_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q14 | Q25 |

Each pin name in parentheses indicates the DDR2 DIMM signal name
DNU - Do not use
NC - No internal connection

## Logic Diagram for 1:1 Register Configuration (Positive Logic); C0 = 0, C1 = 0



To 21 Other Channels (D3, D5, D6, D8-D25)

Parity Logic Diagram for 1:1 Register Configuration (Positive Logic); C0 = 0, C1 = 0



Terminal Assignments for 1:2 Register-A (C0 = 0, C1 = 1)

|  | 1 | 2 | 3 | 4 | 5 | 6 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | D1 (DCKE) | PPO | $V_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q1A (QCKEA) | Q1B (QCKEB) |
| B | D2 | DNU | GND | GND | Q2A | Q2B |
| C | D3 | DNU | $V_{C C}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q3A | Q3B |
| D | D4 (DODT) | QERR | GND | GND | Q4A (QODTA) | Q4B(QODTB) |
| E | D5 | DNU | $V_{C C}$ | $V_{\text {cc }}$ | Q5A | Q5B |
| F | D6 | DNU | GND | GND | Q6A | Q6B |
| G | PAR_IN | RESET | $V_{C C}$ | $\mathrm{V}_{\mathrm{CC}}$ | C1 | C0 |
| H | CLK | D7 ( $\overline{\mathrm{CCS}})$ | GND | GND | Q7A ( $\overline{\text { QCSA }}$ ) | Q7B ( $\overline{\text { QCSB }}$ ) |
| J | $\overline{\text { CLK }}$ | $\overline{\mathrm{CSR}}$ | $V_{C C}$ | $\mathrm{V}_{\mathrm{CC}}$ | NC | NC |
| K | D8 | DNU | GND | GND | Q8A | Q8B |
| L | D9 | DNU | $V_{\text {CC }}$ | $V_{\text {cc }}$ | Q9A | Q9B |
| M | D10 | DNU | GND | GND | Q10A | Q10B |
| N | D11 | DNU | $V_{C C}$ | $\mathrm{V}_{\mathrm{Cc}}$ | Q11A | Q11B |
| P | D12 | DNU | GND | GND | Q12A | Q12B |
| R | D13 | DNU | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q13A | Q13B |
| T | D14 | DNU | $V_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q14A | Q14B |

Each pin name in parentheses indicates the DDR2 DIMM signal name.
DNU - Do not use
NC - No internal connection

## Logic Diagram for 1:2 Register-A Configuration (Positive Logic); C0 = 0, C1 = 1



Parity Logic Diagram for 1:2 Register-A Configuration (Positive Logic); C0 = 0, C1 = 1


|  | PACKAGE (TOP VIEW) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 | 2 | 3 |  |  | 5 | 6 |
| $A \quad(0)(1)()()$ |  |  |  |  |  |  |  |
| B | () () () () () () |  |  |  |  |  |  |
| c | () () () () () () |  |  |  |  |  |  |
| D | () () () () () () |  |  |  |  |  |  |
| E | () () () () () () |  |  |  |  |  |  |
| F | () () () () () () |  |  |  |  |  |  |
| G | () () () () () () |  |  |  |  |  |  |
| H | () () () () () () |  |  |  |  |  |  |
| J | () () () () () () |  |  |  |  |  |  |
| K | () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
| m | () () () () () () |  |  |  |  |  |  |
| N | () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |
| R | () () () () () () |  |  |  |  |  |  |
|  | () () () () () () |  |  |  |  |  |  |

Terminal Assignments for 1:2 Register- $\mathrm{B}(\mathrm{CO}=1, \mathrm{C} 1=1)$

|  | 1 | 2 | 3 | 4 | 5 | 6 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | D1 | PPO | $\mathrm{V}_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q1A | Q1B |
| B | D2 | DNU | GND | GND | Q2A | Q2B |
| C | D3 | DNU | $V_{C C}$ | $\mathrm{V}_{\text {CC }}$ | Q3A | Q3B |
| D | D4 | $\overline{\text { QERR }}$ | GND | GND | Q4A | Q4B |
| E | D5 | DNU | $V_{\text {CC }}$ | $V_{\text {CC }}$ | Q5A | Q5B |
| F | D6 | DNU | GND | GND | Q6A | Q6B |
| G | PAR_IN | RESET | $\mathrm{V}_{\mathrm{CC}}$ | $V_{\text {CC }}$ | C1 | C0 |
| H | CLK | D7 ( $\overline{\mathrm{DCS}}$ ) | GND | GND | Q7A ( $\overline{\mathrm{QCSA}})$ | Q7B ( $\overline{\mathrm{QCSB}})$ |
| J | $\overline{\text { CLK }}$ | $\overline{\mathrm{CSR}}$ | $V_{C C}$ | $\mathrm{V}_{\text {CC }}$ | NC | NC |
| K | D8 | DNU | GND | GND | Q8A | Q8B |
| L | D9 | DNU | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q9A | Q9B |
| M | D10 | DNU | GND | GND | Q10A | Q10B |
| N | D11 (DODT) | DNU | $V_{\text {CC }}$ | $\mathrm{V}_{\text {CC }}$ | Q11A (QODTA) | Q11B (QODTB) |
| P | D12 | DNU | GND | GND | Q12A | Q12B |
| R | D13 | DNU | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {cc }}$ | Q13A | Q13B |
| T | D14 (DCKE) | DNU | $V_{\text {REF }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Q14A (QCKEA) | Q14B (QCKEB) |

Each pin name in parentheses indicates the DDR2 DIMM signal name.
DNU - Do not use
NC - No internal connection

Logic Diagram for 1:2 Register-B Configuration C0 = 1, C1 = 1


Parity Logic Diagram for 1:2 Register-B Configuration (Positive Logic); C0 = 1, C1 = 1


## PIN FUNCTIONS

| NAME | DESCRIPTION | ELECTRICAL CHARACTERISTICS |
| :---: | :---: | :---: |
| GND | Ground | Ground input |
| $\mathrm{V}_{\text {CC }}$ | Power-supply voltage | $1.8 \mathrm{~V} / 1.5 \mathrm{~V}$ nominal |
| $\mathrm{V}_{\text {REF }}$ | Input reference voltage | $0.9 \mathrm{~V} / 0.75 \mathrm{~V}$ nominal |
| CLK | Positive master clock input | Differential input |
| $\overline{\text { CLK }}$ | Negative master clock input | Differential input |
| C0, C1 | Configuration control input. Register A or Register B and 1:1 mode or 1:2 mode select. | LVCMOS inputs |
| RESET | Asynchronous reset input. Resets registers and disables $\mathrm{V}_{\text {REF }}$, data, and clock differential-input receivers. When RESET is low, all Q outputs are forced low and the QERR output is forced high. | LVCMOS input |
| D1-D25 | Data input. Clocked in on the crossing of the rising edge of CLK and the falling edge of CLK. | SSTL_18 inputs / SSTL_15 inputs |
| $\overline{\overline{C S R}, ~ \overline{D C S}}$ | Chip select inputs. Disables D1-D25 ${ }^{(1)}$ outputs switching when both inputs are high | SSTL_18 inputs / SSTL_15 inputs |
| DODT | The outputs of this register bit will not be suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control. | SSTL_18 input / SSTL_15 inputs |
| DCKE | The outputs of this register bit will not be suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control. | SSTL_18 input / SSTL_15 inputs |
| PAR_IN | Parity input. Arrives one clock cycle after the corresponding data input. Pull-down resistor of typical $150 \mathrm{k} \Omega$ to GND. | SSTL_18 input / SSTL_15 inputs, Pull-down |
| Q1-Q25 ${ }^{(2)}$ | Data outputs that are suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control. | 1.8 V / 1.5 V CMOS outputs |
| PPO | Partial parity out. Indicates odd parity of inputs D1-D25. ${ }^{(1)}$ | 1.8 V / 1.5 V CMOS output |
| $\overline{\text { QCS }}$ | Data output that will not be suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control | $1.8 \mathrm{~V} / 1.5 \mathrm{~V}$ CMOS output |
| QODT | Data output that will not be suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control | $1.8 \mathrm{~V} / 1.5 \mathrm{~V}$ CMOS output |
| QCKE | Data output that will not be suspended by the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ control | $1.8 \mathrm{~V} / 1.5 \mathrm{~V}$ CMOS output |
| QERR | Output error bit. Timing is determined by the device mode. | Open-drain output |
| NC | No internal connection |  |
| DNU | Do not use. Inputs are in standby-equivalent mode, and outputs are driven low. |  |

(1) Data inputs $=\mathrm{D} 2, \mathrm{D} 3, \mathrm{D} 5, \mathrm{D} 6, \mathrm{D} 8-\mathrm{D} 25$ when $\mathrm{C} 0=0$ and $\mathrm{C} 1=0$

Data inputs $=\mathrm{D} 2, \mathrm{D} 3, \mathrm{D} 5, \mathrm{D} 6, \mathrm{D} 8-\mathrm{D} 14$ when $\mathrm{C} 0=0$ and $\mathrm{C} 1=1$
Data inputs = D1-D6, D8-D10, D12, D13 when C0 = 1 and C1 = 1.D
(2) Data outputs = Q2, Q3, Q5, Q6, Q8-Q25 when $\mathrm{C} 0=0$ and $\mathrm{C} 1=0$

Data outputs = Q2, Q3, Q5, Q6, Q8-Q14 when $\mathrm{C} 0=0$ and $\mathrm{C} 1=1$
Data outputs = Q1-Q6, Q8-Q10, Q12, Q13 when $C 0=1$ and $C 1=1$.

## FUNCTION TABLE

| INPUTS |  |  |  |  |  | OUTPUTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESET | $\overline{\text { DCS }}$ | CSR | CLK | CLK | Dn | Qn |
| H | L | X | $\uparrow$ | $\downarrow$ | L | L |
| H | L | X | $\uparrow$ | $\downarrow$ | H | H |
| H | X | L | $\uparrow$ | $\downarrow$ | L | L |
| H | X | L | $\uparrow$ | $\downarrow$ | H | H |
| H | H | H | $\uparrow$ | $\downarrow$ | X | $Q_{0}$ |
| H | $X$ | $X$ | L or H | L or H | X | $Q_{0}$ |
| L | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | L |

## FUNCTION TABLE

| INPUTS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { RESET }}$ | CLK | $\overline{\text { CLK }}$ | DCKE, $\overline{\text { DCS, }} \overline{\text { DODT }}$ | QCKE, $\overline{\text { QCS, QODT }}$ |
| H | $\uparrow$ | $\downarrow$ | H | H |
| H | $\uparrow$ | $\downarrow$ | L | L |
| H | L or H | L or H | X | $\mathrm{Q}_{0}$ |
| L | X or Floating | X or Floating | X or Floating | L |

## PARITY AND STANDBY FUNCTION

| INPUTS |  |  |  |  |  |  | OUTPUTS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { RESET }}$ | CLK | $\overline{\text { CLK }}$ | $\overline{\text { DCS }}$ | $\overline{\text { CSR }}$ | $\underset{\text { D1-D25 }}{ } \underset{\text { (1) }}{\text { OF INPUUS }}$ | PAR_IN ${ }^{(2)}$ | PPO | $\overline{\text { QERR }}{ }^{(3)}$ |
| H | $\uparrow$ | $\downarrow$ | L | X | Even | L | L | H |
| H | $\uparrow$ | $\downarrow$ | L | X | Odd | L | H | L |
| H | $\uparrow$ | $\downarrow$ | L | X | Even | H | H | L |
| H | $\uparrow$ | $\downarrow$ | L | X | Odd | H | L | H |
| H | $\uparrow$ | $\downarrow$ | H | L | Even | L | L | H |
| H | $\uparrow$ | $\downarrow$ | H | L | Odd | L | H | L |
| H | $\uparrow$ | $\downarrow$ | H | L | Even | H | H | L |
| H | $\uparrow$ | $\downarrow$ | H | L | Odd | H | L | H |
| H | $\uparrow$ | $\downarrow$ | H | H | X | X | $\mathrm{PPO}_{0}$ | $\overline{\text { QERR }}_{0}$ |
| H | L or H | L or H | X | X | X | X | $\mathrm{PPO}_{0}$ | $\overline{\text { QERR }}_{0}$ |
| L | $X$ or Floating | $\begin{aligned} & \text { X or } \\ & \text { Floating } \end{aligned}$ | $\begin{gathered} \text { X or } \\ \text { Floating } \end{gathered}$ | X or Floating | X | X or Floating | L | H |

(1) Data inputs = D2-D3, D5-D6, D8-D25 when $\mathrm{C} 0=0$ and C1 $=0$

Data inputs = D2-D3, D5-D6, D8-D14 when C0 $=0$ and C1 $=1$
Data inputs = D1-D6, D8-D10, D12, D13 when $\mathrm{C} 0=1$ and $\mathrm{C} 1=1$
(2) PAR_IN arrives one clock cycle ( $\mathrm{CO}=0$ ) or two clock cycles ( $\mathrm{CO}=1$ ) after the data to which it applies.
(3) This transition assumes that QERR is high at the crossing of CLK going high and CLK going low. If QERR goes low, it stays latched low for a minimum of two clock cycles or until RESET is driven low. If two or more consecutive parity errors occur, the QERR output is driven low and latched low for a clock duration equal to the parity duration or until RESET is driven low.

PARITY ERROR DETECT IN LOW-POWER MODE ${ }^{(1)}$

| $\begin{aligned} & \text { INPUT-DATA } \\ & \text { ERROR } \\ & \text { OCCURRENCE } \end{aligned}$ | $\begin{gathered} 1: 1 \text { MODE } \\ (C 0=0, C 1=0) \end{gathered}$ |  | 1:2 REGISTER-A MODE$(C 0=0, C 1=1)$ |  | 1:2 REGISTER-B MODE$(C 0=1, C 1=1)$ |  | CASCADED MODE (Registers A and B) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\begin{gathered} \text { PPO } \\ \text { DURATION }{ }^{(3)} \end{gathered}$ | $\begin{gathered} \text { QERR } \\ \text { DURATION }^{(3)} \end{gathered}$ | $\begin{gathered} \text { PPO } \\ \text { DURATION }{ }^{(3)} \end{gathered}$ | $\begin{gathered} \text { QERR } \\ \text { DURATION }^{(3)} \end{gathered}$ | $\begin{gathered} \text { PPO } \\ \text { DURATION }{ }^{(3)} \end{gathered}$ | $\begin{gathered} \text { QERR } \\ \text { DURATION }{ }^{(3)} \end{gathered}$ | $\begin{gathered} \text { PPO } \\ \text { DURATION }{ }^{(3)} \end{gathered}$ | $\begin{gathered} \text { QERR } \\ \text { DURATION }^{(3)} \end{gathered}$ |
| n-4 | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles |
| $\mathrm{n}-3$ | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles |
| $\mathrm{n}-2$ | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles | 1 Cycle | 2 Cycles |
| $\mathrm{n}-1$ | $\begin{gathered} \text { LPM }+2 \\ \text { Cycles } \end{gathered}$ | LPM + 2 Cycles | LPM + 1 Cycle | $\begin{gathered} \text { LPM + } 1 \\ \text { Cycle } \end{gathered}$ | LPM + 2 Cycles | LPM + 2 Cycles | LPM + 2 Cycles | LPM + 2 Cycles |
| n | Not detected | Not detected | Not detected | Not detected | Not detected | Not detected | Not detected | Not detected |

(1) If a parity error occurs before the device enters the low-power mode (LPM), the behavior of PPO and QERR is dependent on the mode of the device and the position of the parity error occurrence. This table illustrates the low-power-mode effect on parity detect. The low-power mode is activated on the n clock cycle when DCS and CSR go high.
(2) The clock-edge position of a one cycle data-input error relative to the clock-edge ( $n$ ) which initiates LPM at the $\overline{\mathrm{DCS}}$ and $\overline{\mathrm{CSR}}$ inputs.
(3) If an error occurs, then QERR output may be driven low and the PPO output driven high. These columns show the clock duration for which the PPO signal will be high.

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

|  |  |  | VALUE | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage range |  | -0.5 to 2.5 | V |
| $\mathrm{V}_{1}$ | Input voltage range ${ }^{(2)(3)}$ |  | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage range ${ }^{(2)(3)}$ |  | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| IK | Input clamp current, ( $\mathrm{V}_{1}<0$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{CC}}$ ) |  | $\pm 50$ | mA |
| lok | Output clamp current, ( $\mathrm{V}_{\mathrm{O}}<0$ or $\mathrm{V}_{\mathrm{O}}>\mathrm{V}^{\prime}$ |  | $\pm 50$ | mA |
| lo | Continuous output current ( $\mathrm{V}_{\mathrm{O}}=0$ to $\mathrm{V}_{\mathrm{Cc}}$ ) |  | $\pm 50$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | Continuous current through each $\mathrm{V}_{\mathrm{CC}}$ or | GND | $\pm 100$ | mA |
|  |  | No airflow | 39.8 |  |
|  | Thermal impeda | Airflow $150 \mathrm{ft} / \mathrm{min}$ | 34.1 |  |
| $\mathrm{R}_{\text {өJA }}$ | junction-to-ambient ${ }^{(4)}$ | Airflow $250 \mathrm{ft} / \mathrm{min}$ | 33.6 | K/W |
|  |  | Airflow $500 \mathrm{ft} / \mathrm{min}$ | 32.5 |  |
| $\mathrm{R}_{\text {өJc }}$ | Thermal resistance, junction-to-case ${ }^{(4)}$ | No airflow | 14.5 |  |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(3) This value is limited to 2.5 V maximum.
(4) The package thermal impedance is calculated in accordance with JESD 51-7.

## RECOMMENDED OPERATING CONDITIONS ${ }^{(1)}$

|  |  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {cc }}$ | Supply voltage | 1.8 V Range | 1.7 | 1.8 | 1.9 | V |
|  |  | 1.5 V Range | 1.425 | 1.5 | 1.575 |  |
| $\mathrm{V}_{\text {REF }}$ | Reference voltage |  | $0.49 \times \mathrm{V}_{\text {CC }}$ | $0.5 \times V_{\text {cC }}$ | $0.51 \times \mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{TT}}$ | Termination voltage |  | $\mathrm{V}_{\text {REF }}-40 \mathrm{mV}$ | $\mathrm{V}_{\text {REF }}$ | $\mathrm{V}_{\text {REF }}+40 \mathrm{mV}$ | V |
| $V_{1}$ | Input voltage |  | 0 |  | VCC | V |
| $\mathrm{V}_{\mathrm{IH}}$ | AC high-level input voltage | Data inputs, $\overline{\text { CSR }, ~ P A R \_I N ~}$ | $\mathrm{V}_{\text {REF }}+250 \mathrm{mV}$ |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | AC low-level input voltage | Data inputs, $\overline{C S R}$, PAR_IN |  |  | $\mathrm{V}_{\text {REF }}-250 \mathrm{mV}$ | V |
| $\mathrm{V}_{\mathrm{IH}}$ | DC high-level input voltage | Data inputs, $\overline{C S R}$, PAR_IN | $\mathrm{V}_{\text {REF }}+125 \mathrm{mV}$ |  |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | DC low-level input voltage | Data inputs, $\overline{\mathrm{CSR}}, \mathrm{PAR}$ _IN |  |  | $\mathrm{V}_{\text {REF }}$-125 mV | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | RESET, $\mathrm{C}_{\mathrm{n}}$ | $0.65 \times \mathrm{V}_{\mathrm{CC}}$ |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | RESET, $\mathrm{C}_{\mathrm{n}}$ |  |  | $0.35 \times \mathrm{V}_{\text {CC }}$ | V |
| $\mathrm{V}_{\text {ICR }}$ | Common-mode input voltage range | CLK, $\overline{\text { CLK }}$ | $\mathrm{V}_{\text {REF }}-0.175$ |  | $\mathrm{V}_{\text {REF }}+0.175$ | V |
| $\mathrm{V}_{\text {l(PP) }}$ | Peak-to-peak input voltage | CLK, $\overline{\text { CLK }}$ | 600 |  |  | mV |
| $\mathrm{I}_{\mathrm{OH}}$ | High-level output current | Q outputs, PPO |  |  | -8 | mA |
|  |  | Q outputs, PPO |  |  | 8 | mA |
| OL | Low-level output current | $\overline{\text { QERR }}$ output | 30 |  |  | mA |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature |  | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

(1) The RESET and Cn inputs of the device must be held at valid logic voltage levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless RESET is low. See the TI application report, Implications of Slow or Floating CMOS Inputs (SCBA004).

InSTRUMENTS

## ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{cc}}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | Q outputs, PPO | $\mathrm{IOH}=-100 \mu \mathrm{~A}$ |  | 1.7V to 1.9V | $\mathrm{V}_{\mathrm{CC}}-0.2$ |  |  | V |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-6 \mathrm{~mA}$ |  | 1.7 V | 1.3 |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |  | $\begin{aligned} & \hline 1.425 \mathrm{~V} \text { to } \\ & 1.575 \mathrm{~V} \end{aligned}$ | $\mathrm{V}_{\mathrm{CC}}-0.2$ |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-6 \mathrm{~mA}$ |  | 1.425 V | 1.0 |  |  |  |
| $\mathrm{V}_{\text {OL }}$ | Q outputs, PPO | $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ |  | 1.7 V to 1.9 V |  |  | 0.2 | V |
|  |  | $\mathrm{l}_{\mathrm{OL}}=6 \mathrm{~mA}$ |  | 1.7 V |  |  | 0.4 |  |
|  |  | $\mathrm{loL}=100 \mu \mathrm{~A}$ |  | $\begin{aligned} & 1.425 \mathrm{~V} \text { to } \\ & 1.575 \mathrm{~V} \end{aligned}$ |  |  | 0.2 |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=6 \mathrm{~mA}$ |  | 1.425 V |  |  | 0.4 |  |
|  | $\overline{\text { QERR }}$ output | $\mathrm{l}_{\mathrm{OL}}=25 \mathrm{~mA}$ |  | 1.7 V |  |  | 0.5 |  |
|  |  | $\mathrm{l}_{\mathrm{OL}}=25 \mathrm{~mA}$ |  | 1.425 V |  |  | 0.5 |  |
| 1 | PAR_IN | $\mathrm{V}_{1}=$ GND |  | 1.9V |  |  | -5 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ |  |  |  |  | 25 |  |
|  | All other inputs ${ }^{(2)}$ | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or GND |  |  |  |  | $\pm 5$ |  |
| $\mathrm{I}_{\text {Oz }} \overline{\text { QERR }}$ output |  | $\mathrm{VO}=\mathrm{V}_{\text {CC }}$ or GND |  | 1.9 V |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| Icc | Static standby | $\overline{\mathrm{RESET}}=\mathrm{GND}$ | $\mathrm{l}_{0}=0$ | 1.9V |  |  | 200 | $\mu \mathrm{A}$ |
|  | Static operating | $\overline{\text { RESET }}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}(\mathrm{AC})}$ |  |  |  |  | 40 | mA |
| $I_{\text {CCD }}$ | Dynamic operating - clock only | $\overline{\mathrm{RESET}}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}(\mathrm{AC})}$, CLK and CLK switching $50 \%$ duty cycle | $\mathrm{I}_{0}=0$ | 1.8 V |  | 45 |  | $\mu \mathrm{A} / \mathrm{MHz}$ |
|  | Dynamic operating - per each data input, 1:1 configuration | $\overline{\operatorname{RESET}}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}(\mathrm{AC})}$, CLK and CLK switching $50 \%$ duty cycle, one data input switching at one-half clock frequency, $50 \%$ duty cycle |  |  |  | 43 |  | $\mu \mathrm{A}$ clock MHz/D input |
|  | Dynamic operating - per each data input, 1:2 configuration |  |  |  |  | 60 |  |  |
| $\left\lvert\, \begin{aligned} & \mathrm{I} \mathrm{CCDL} \\ & \mathrm{P} \end{aligned}\right.$ | Chip-select-enabled low-power active mode clock only | $\overline{R E S E T}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}(\mathrm{AC})}$, CLK and CLK switching $50 \%$ duty cycle | $\mathrm{l}_{0}=0$ | 1.8 V |  | 45 |  | $\mu \mathrm{A} / \mathrm{MHz}$ |
|  | Chip-select-enabled low-power active mode 1:1 configuration | $\overline{\operatorname{RESET}}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}(\mathrm{AC})}$, CLK and CLK switching $50 \%$ duty cycle, one data input switching at one-half clock frequency, $50 \%$ duty cycle |  |  |  | 2 |  | $\mu \mathrm{A}$ clock MHz/D input |
|  | Chip-select-enabled low-power active mode 1:2 configuration |  |  |  |  | 3 |  |  |
| $\mathrm{C}_{1}$ | Data inputs, $\overline{\mathrm{CSR}}, \mathrm{PAR}$ _IN | $\mathrm{V}_{1}=\mathrm{V}_{\text {REF }} \pm 250 \mathrm{mV}$ |  | 1.8 V | 2.5 | 3 | 3.5 | pF |
|  | CLK, $\overline{\text { CLK }}$ | $\mathrm{V}_{\text {ICR }}=0.9 \mathrm{~V}, \mathrm{~V}_{\text {l(PP) }}=600 \mathrm{mV}$ |  |  | 2 |  | 3 |  |
|  | RESET | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND |  |  |  | 4 |  |  |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) Each $V_{\text {REF }}$ pin (A3 or $T 3$ ) should be tested independently, with the other (untested) pin open.

## TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 and ${ }^{(1)}$

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| fclock | Clock frequency |  |  | 410 | MHz |
| tw | Pulse duration, CLK, CLK high or low |  | 1 |  | ns |
| tact | Differential inputs active time ${ }^{(2)} 1.8 \mathrm{~V}$ Range |  |  | 10 | ns |
| tinact | Differential inputs inactive time ${ }^{(3)} 1.8 \mathrm{~V}$ Range |  |  | 15 | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time | $\overline{\mathrm{DCS}}$ before CLK $\uparrow, \overline{\mathrm{CLK}} \downarrow, \overline{\mathrm{CSR}}$ high; $\overline{\mathrm{CSR}}$ before CLK $\uparrow$, $\overline{\mathrm{CLK}} \downarrow, \overline{\mathrm{DCS}}$ high | 600 |  | ps |
|  |  | $\overline{\overline{D C S}}$ before CLK $\uparrow$, $\overline{\mathrm{CLK}} \downarrow$, $\overline{\mathrm{CSR}}$ low | 500 |  |  |
|  |  | DODT, DCKE, and Data before CLK $\uparrow$, $\overline{C L K} \downarrow$ | 500 |  |  |
|  |  | PAR_IN before CLK $\uparrow$, $\overline{\mathrm{CLK}} \downarrow$ | 500 |  |  |
|  | Hold time | $\overline{\text { DCS }}$, DODT, DCKE, and Data after CLK $\uparrow$, $\overline{\mathrm{CLK}} \downarrow$ | 400 |  | ps |
|  |  | PAR_IN after CLK $\uparrow$, $\overline{\mathrm{CLK}} \downarrow$ | 400 |  |  |

(1) All inputs slew rate is $1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$.
(2) $V_{\text {REF }}$ must be held at a valid input level, and data inputs must be held low for a minimum time of tact max, after RESET is taken high.
(3) $V_{\text {REF }}$, data, and clock inputs must be held at valid voltage levels (not floating) for a minimum time of $t_{\text {inact }}$ max, after RESET is taken low.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  |  | FROM (INPUT) | TO (OUTPUT) | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {max }}$ | See Figure 1 | 1.8 V Range |  |  | 410 |  | MHz |
|  |  | 1.5 V Range |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | See Figure 4 | 1.8 V Range | CLK and $\overline{\text { CLK }}$ | PPO | 0.5 | 1.7 | ns |
|  |  | 1.5 V Range |  |  |  |  |  |
| $\mathrm{tPLH}^{(1)}$ | See Figure 3 | 1.8 V Range | CLK and CLK | QERR | 1.2 | 3 | ns |
|  |  | 1.5 V Range |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }}{ }^{(1)}$ | See Figure 3 | 1.8 V Range |  |  | 1 | 2.4 | ns |
|  |  | 1.5 V Range |  |  |  |  |  |
| $\mathrm{t}_{\text {RPHL }}{ }^{(2)}$ | See Figure 1 | 1.8 V Range | $\overline{\text { RESET }}$ | Q | 3 |  | ns |
|  |  | 1.5 V Range |  |  |  |  |  |  |
| $\mathrm{t}_{\text {RPHL }}$ | See Figure 4 | 1.8 V Range |  | PPO | 3 |  |  |
|  |  | 1.5 V Range |  |  |  |  |  |  |
| $\mathrm{t}_{\text {RPLH }}$ | See Figure 4 | 1.8 V Range | RESET | QERR | 3 |  | ns |
|  |  | 1.5 V Range |  |  |  |  |  |  |

(1) This parameter is not included in production test and has to be considered as design goal only.
(2) Includes 350 -ps test-load transmission-line delay.

## OUTPUT SLEW RATES

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM | TO | $\mathrm{V}_{\mathrm{CC}}=1.8 \pm 0.1 \mathrm{~V}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | MAX |  |
| dV/dt_r | 20\% | 80\% | 1 | 4 | V/ns |
| dV/dt_f | 80\% | 20\% | 1 | 4 | V/ns |
| $d V /$ dt_ $\Delta^{(1)}$ | 20\% or $80 \%$ | 80\% or $20 \%$ |  | 1 | V/ns |

(1) Difference between $d V / d t \_r$ (rising edge rate) and dV/dt_f (falling edge rate).

## PARAMETER MEASUREMENT INFORMATION

## PROPAGATION DELAY (Design Goal)

| PARAMETER |  | FROM (INPUT) | TO (OUTPUT) | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {pdm }}{ }^{(1)}$ | 1.8 V Range | CLK and $\overline{C L K}$ | Q | 1.1 | 1.5 | ns |
|  | 1.5 V Range |  |  | 1.3 | 1.7 |  |
| $\mathrm{t}_{\text {pdmss }}{ }^{(1)}$ | 1.8 V Range | CLK and $\overline{C L K}$ | Q |  | 1.6 | ns |
|  | 1.5 V Range |  |  |  | 1.8 |  |

(1) Includes 350 psi test-load transmission delay line


NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. $I_{C C}$ tested with clock and data inputs held at $\mathrm{V}_{\mathrm{CC}}$ or GND, and $\mathrm{l}_{\mathrm{O}}=0 \mathrm{~mA}$.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$, input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$ (unless otherwise noted).
D. The outputs are measured one at a time, with one transition per measurement.
E. $V_{R E F}=V_{T T}=V_{C C} / 2$
F. $V_{I H}=V_{\text {REF }}+250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{CC}}$ for LVCMOS input.
G. $V_{I L}=V_{\text {REF }}-250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{\mathrm{IL}}=$ GND for LVCMOS input.
H. $V_{(P P)}=600 \mathrm{mV}$
I. $t_{\text {PLH }}$ and $t_{\text {PHL }}$ are the same as $t_{\text {pd }}$.

Figure 1. Data Output Load Circuit and Voltage Waveforms


LOAD CIRCUIT
HIGH-TO-LOW SLEW-RATE MEASUREMENT


LOAD CIRCUIT
LOW-TO-HIGH SLEW-RATE MEASUREMENT


VOLTAGE WAVEFORMS HIGH-TO-LOW SLEW-RATE MEASUREMENT


VOLTAGE WAVEFORMS LOW-TO-HIGH SLEW-RATE MEASUREMENT

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$, input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$ (unless otherwise specified).

Figure 2. Data Output Slew-Rate Measurement Information


VOLTAGE WAVEFORMS OPEN-DRAIN OUTPUT TRANSITION TIME (HIGH-TO-LOW)


NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$, input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$ (unless otherwise noted).
C. $t_{P L H}$ and $t_{P H L}$ are the same as $t_{p d}$.

Figure 3. Error Output Load Circuit and Voltage Waveforms


LOAD CIRCUIT


VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES

NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$, input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$ (unless otherwise noted).
C. $\mathrm{V}_{\mathrm{REF}}=\mathrm{V}_{\mathrm{TT}}=\mathrm{V}_{\mathrm{CC}} / 2$
D. $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{REF}}+250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{CC}}$ for LVCMOS input.
E. $V_{I L}=V_{\text {REF }}-250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{\mathrm{IL}}=$ GND for LVCMOS input.
F. $V_{l(P P)}=600 \mathrm{mV}$
G. $t_{P L H}$ and $t_{P H L}$ are the same as $t_{p d}$.

Figure 4. Partial-Parity-Out Load Circuit and Voltage Waveforms

## APPLICATION INFORMATION

The typical values below are for standard raw cards. Test equipment used was the JEDEC register validation board using pattern $0 \times 43,0 \times 4 \mathrm{~F}$, and $0 \times 5 \mathrm{~A}$.

Table 1. Raw Card Values ${ }^{(1)}{ }^{(2)}$

| RAW CARD | $\mathbf{t}_{\text {pdmss }}$ |  | OVERSHOOT |
| :---: | :---: | :---: | :---: |
|  | MIN | MAX |  |
| A/F | 1.2 ns | 1.6 ns | 140 mV |
| $\mathrm{B} / \mathrm{G}$ | 1.3 ns | 2.0 ns | 430 mV |
| $\mathrm{C} / \mathrm{H}$ | 1.3 ns | 2.0 ns | 430 mV |

(1) All values are valid under nominal conditions (1.8V) and minimum/maximum of typical signals on one typical DIMM.
(2) Measurements include all jitter and ISI effects.

SN74SSTEB32866 Used as a Single Device in the 1:1 Register Configuration; C0 = 0, C1 = 0


Timing Diagram for SN74SSTEB32866 Used as a Single Device; C0 $=0, \mathbf{C 1}=0$ ( $\overline{\text { RESET }}$ Switches From Lto H )


H, L, or $\mathbf{X}$


H or L
$\dagger$ After $\overline{R E S E T}$ is switched from low to high, all data and PAR_IN input signals must be set and held low for a minimum time of $t_{\text {act }}$ max, to avoid false error.
$\ddagger$ If the data is clocked in on the $n$ clock pulse, the QERR output signal will be generated on the $n+2$ clock pulse, and it will be valid on the $\mathrm{n}+3$ clock pulse.

Timing Diagram for SN74SSTEB32866 Used as a Single Device; C0 = 0, C1 = 0 ( $\overline{\text { RESET }}=\mathrm{H}$ )

$\dagger$ If the data is clocked in on the $n$ clock pulse, the QERR output signal will be generated on the $n+2$ clock pulse, and it will be valid on $n+3$ clock pulse. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until $\overline{\text { RESET }}$ is driven low.

Timing Diagram for SN74SSTEB32866 Used as a Single Device; C0 = 0, C1 = 0 ( $\overline{\text { RESET }}$ Switches From = H to L)

$\dagger$ After RESET is switched from high to low, all data and clock input signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text {inact }}$ max.

SN74SSTEB32866 Used in Pair in the 1:2 Register Configuration


[^1]Timing Diagram for the First SN74SSTEB32866 (1:2 Register-A Configuration) Device Used in Pair; C0 = 0, C1 = 1 (RESET Switches From L to H)

$\dagger$ After $\overline{R E S E T}$ is switched from low to high, all data and PAR_IN input signals must be set and held low for a minimum time of $t_{\text {act }}$ max, to avoid false error.
\#lf the data is clocked in on the $n$ clock pulse, the $\overline{\text { QERR }}$ output signal will be generated on the $n+1$ clock pulse, and it will be valid on the $\mathrm{n}+2$ clock pulse.

Timing Diagram for the First SN74SSTEB32866 (1:2 Register-A Configuration) Device Used in Pair; C0 = 0, C1 = $1(\overline{\text { RESET }}=\mathrm{H})$

$\dagger$ If the data is clocked in on the $n$ clock pulse, the $\overline{Q E R R}$ output signal will be generated on the $n+1$ clock pulse, and it will be valid on $n+2$ clock pulse. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low.

Timing Diagram for the First SN74SSTEB32866 (1:2 Register-A Configuration) Device Used in Pair; C0 = 0, C1 = 1 (RESET = Switches From H to L)

$\dagger$ After RESET is switched from high to low, all data and clock input signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text {inact }}$ max.

Timing Diagram for the Second SN74SSTEB32866 (1:2 Register-B Configuration) Device Used in Pair; C0 = 1, C1 = 1 (RESET = Switches From L to H)


[^2]Timing Diagram for the Second SN74SSTEB32866 (1:2 Register-B Configuration) Device Used in Pair; C0 = 1, C1 = $1(\overline{\text { RESET }}=\mathrm{H})$

$\dagger$ PAR_IN is driven from PPO of the first SN74SSTUB32866 device.
$\ddagger$ If the data is clocked in on the $n$ clock pulse, the QERR output signal will be generated on the $n+2$ clock pulse, and it will be valid on $n+3$ clock pulse. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low.

Timing Diagram for the Second SN74SSTEB32866 (1:2 Register-B Configuration) Device Used in Pair; C0 = 1, C1 = 1 (RESET = Switches From H to L)


[^3]
## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74SSTEB32866ZWLR | ACTIVE | BGA | ZWL | 96 | 1000 | RoHS \& Green | SNAGCU | Level-3-260C-168 HR | -40 to 85 | SEB866 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $\mathbf{W 1}(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74SSTEB32866ZWLR | BGA | ZWL | 96 | 1000 | 330.0 | 24.4 | 5.7 | 13.7 | 2.0 | 8.0 | 24.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74SSTEB32866ZWLR | BGA | ZWL | 96 | 1000 | 350.0 | 350.0 | 43.0 |

ZWL (R-PBGA-N96)


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Falls within JEDEC MO-205 variation CC.
D. This package is lead-free. Refer to the 96 GWL package (drawing 4206045) for tin-lead (SnPb).

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[^0]:    Widebus+ is a trademark of Texas Instruments.

[^1]:    $\dagger$ This function holds the error for two cycles. For details, see the parity logic diagram.

[^2]:    $\dagger$ After $\overline{R E S E T}$ is switched from low to high, all data and PAR_IN input signals must be set and held low for a minimum time of $t_{\text {act }}$ max, to avoid false error.
    $\neq P A R \_I N$ is driven from PPO of the first SN74SSTUB32866 device.
    § If the data is clocked in on the $n$ clock pulse, the QERR output signal will be generated on the $n+2$ clock pulse, and it will be valid on the $\mathrm{n}+3$ clock pulse.

[^3]:    $\dagger$ After $\overline{R E S E T}$ is switched from high to low, all data and clock input signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text {inact }}$ max.

